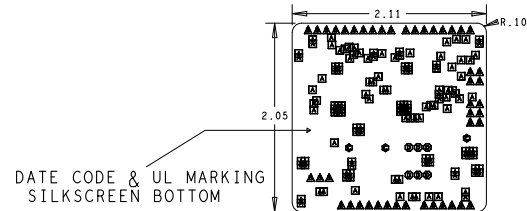


REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
01	ALPHA RELEASE	12/23/14	GVCH



DRILL CHART: TOP to BOTTOM				
ALL UNITS ARE IN MILS				
FIGURE	SIZE	TOLERANCE	PLATED	QTY
■	10.0	+3.0/-3.0	PLATED	134
▲	40.0	+3.0/-3.0	PLATED	45
●	42.99	+3.0/-3.0	PLATED	3
●	60.0	+3.0/-3.0	PLATED	6

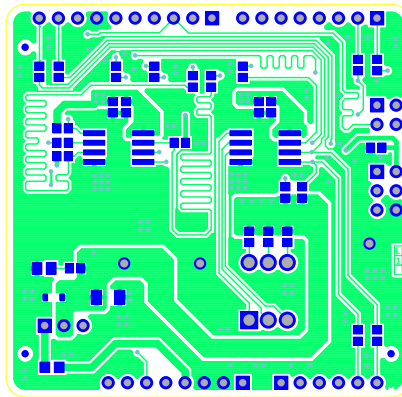
NOTES:(UNLESS OTHERWISE SPECIFIED)

1. RoHS COMPLIANT CERTIFICATION OR MATERIAL DECLARATION REQUIRED.
2. MATERIAL:
 - A. IS410 OR EQUIVALENT. MATERIAL MUST CONFORM TO UL94V-0.
 - B. USE HTE COPPER, AS SPECIFIED IN THE CROSS SECTION DIAGRAM.
 - C. OVERALL METAL TO METAL THICKNESS AS SPECIFIED IN THE CROSS SECTION.
3. DRILLING:
 - A. DIAMETERS IN DRILL TABLE ARE FINISHED HOLE SIZES +/- .003 to 1. UNLESS OTHERWISE SPECIFIED IN DRILL TABLE.
 - B. TEARDROP ALLOWED ON ENTRY OF VIA ON EVERY TRACE LAYER.
4. PLATING:

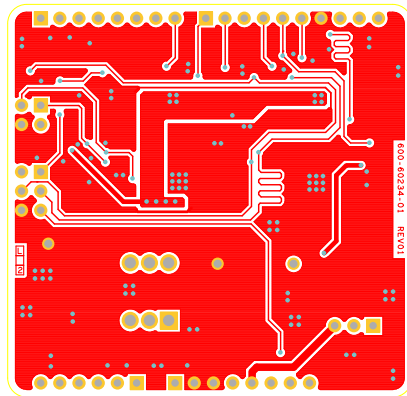
COPPER PLATING IN THRU-HOLES .001 min.
5. MARKING:
 - A. SILKSCREEN IN WHITE NON-CONDUCTIVE EPOXY INK ON PRIMARY SIDE OF THE BOARD OR BOTH SIDES IF APPLICABLE.
 - B. FABRICATOR TO PLACE DATE CODE, LOGO AND RoHS COMPLIANT SYMBOL IN SILKSCREEN ON SECONDARY SIDE.
6. FINAL FABRICATION:
 - A. SOLDRMASK PRIMARY AND SECONDARY SIDE OF BOARD USING LIQUID PHOTOIMAGABLE MASK MATERIAL OVER BARE COPPER. PER IPC-SM-840. MASK ARTWORKS PROVIDED ARE 1:1. SOLDRMASK COLOR **BLUE**
7. FINISH:
 - A. SHALL BE ELECTROLESS NIKEL / IMMERSION GOLD(ENIG).
 - B. NICKEL THICKNESS: 100-200 MICROINCHES.
 - C. GOLD THICKNESS: 3-10 MICROINCHES.
8. BOARDS SHALL BE PURCHASED FROM UL RECOGNIZED VENDORS ONLY.

FLAMABILITY RATING (94-V0).
9. MANUFACTURE BOARD TO BE IN ACCORDANCE WITH PERFORMANCE STANDARD IPC-6011/6012 CLASS 2 BOARD TO BE INSPECTED PER IPC-600-A CLASS 2.
10. MAXIMUM WRAP OR TWIST SHALL NOT EXCEED .007 in/in.
11. MINIMUM CONDUCTOR WIDTH 8.00 MILS
MINIMUM SPACING 8.00 MILS

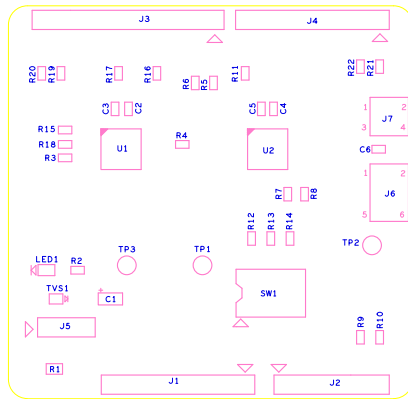
UNLESS OTHERWISE SPECIFIED		SIGNATURES	DATE	 198 CHAMPION COURT SAN JOSE, CA 95134 (408) 943-2600	
DIMENSIONS ARE IN INCHES		DRAWN ECAD	12/23/14		
TOLERANCES ON: 2 PL DECIMALS +/- .010 3 PL DECIMALS +/- .005		CHECKED GVCH	12/23/14		
THIRD ANGLE PROJECTIONS		ENGRG GVCH	12/23/14		
CYPRESS PROPRIETARY THIS DOCUMENT CONTAINS CONFIDENTIAL, PROPRIETARY INFORMATION THAT IS CYPRESS SEMICONDUCTOR PROPERTY. DO NOT DISCLOSE TO OR DUPLICATE FOR OTHERS EXCEPT AS AUTHORIZED BY CYPRESS.		ISSUED		FABRICATION DRAWING CY15FRAMKIT-001	
				SIZE C	FSCM NO
				DWG NO 610-60224-01	REV 01
				SHEET: 2 OF 2	



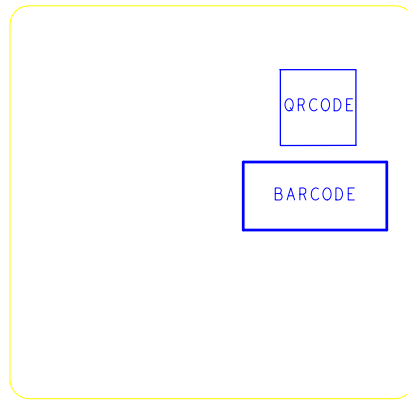
PRIMARY SIDE 600-60234-01 REV01



SECONDARY SIDE 600-60234-01 REV01



ASSEMBLY PRIMARY 600-60234-01 REV01



ASSEMBLY SECONDARY 600-60234-01 REV01